



US00D528020S

(12) **United States Design Patent**
Brown et al.

(10) **Patent No.:** **US D528,020 S**

(45) **Date of Patent:** **** Sep. 12, 2006**

(54) **PROCESS DEVICE**

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(73) Assignee: **Rosemount Inc.**, Eden Prairie, MN (US)

(**) Term: **14 Years**

(21) Appl. No.: **29/204,502**

(22) Filed: **Apr. 29, 2004**

(51) **LOC (8) Cl.** **10-04**

(52) **U.S. Cl.** **D10/46**

(58) **Field of Classification Search** D14/299;
D10/46, 102; 73/718, 861.02, 861.03, 861.22,
73/861.24, 861.52

See application file for complete search history.

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(57) **CLAIM**

The ornamental design for a process device, as shown and described.

DESCRIPTION

FIG. 1 is a front elevational view of a process device showing my new design;

FIG. 2 is a right side elevation view of a first embodiment;

FIG. 3 is a rear elevation view of a first embodiment;

FIG. 4 is a left side elevation view of a first embodiment;

FIG. 5 is a top plan view of a first embodiment;

FIG. 6 is a bottom plan view of a first embodiment;

FIG. 7 is a perspective view of a first embodiment;

FIG. 8 is a front elevational view of a second embodiment of a process device showing my new design;

FIG. 9 is a right side elevation view of a second embodiment;

FIG. 10 is a rear elevation view of a second embodiment;

FIG. 11 is a left side elevation view of a second embodiment;

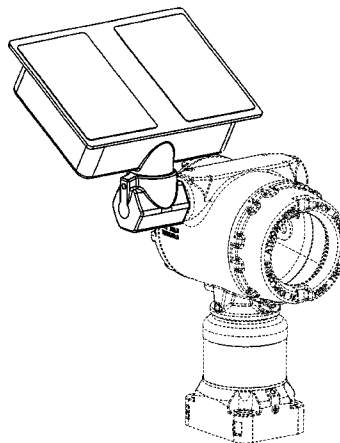
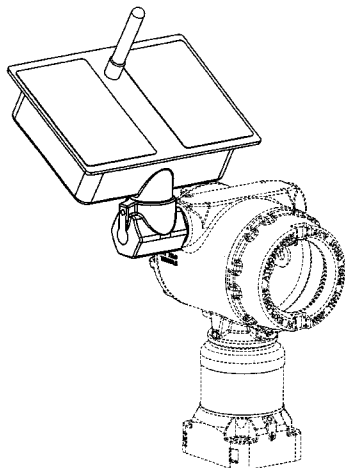
FIG. 12 is a top plan view of a second embodiment;

FIG. 13 is a bottom plan view of a second embodiment; and,

FIG. 14 is a perspective view of a second embodiment.

The broken lines are for illustrative purposes only and forms no part of the claimed design.

1 Claim, 14 Drawing Sheets



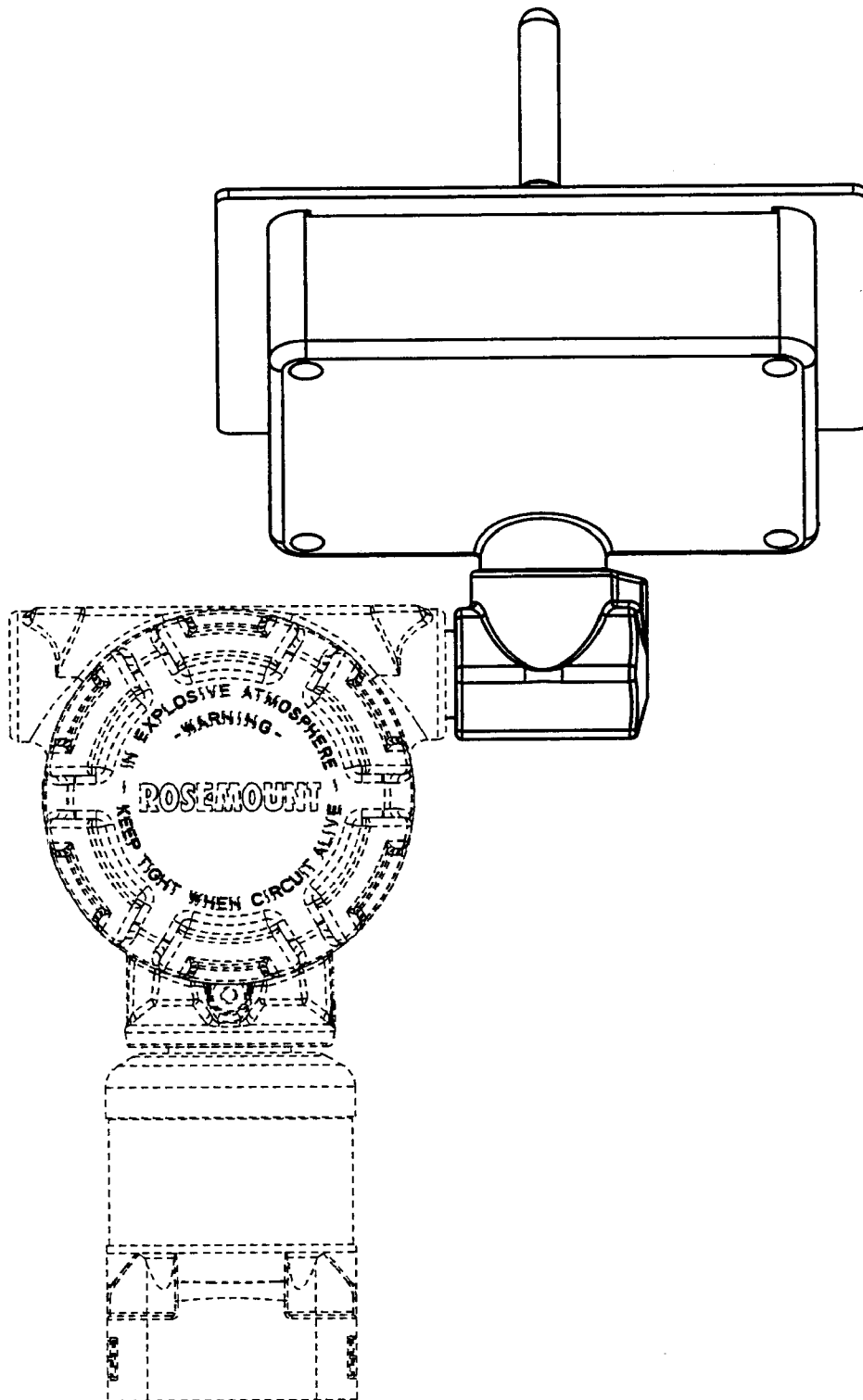


Fig. 1

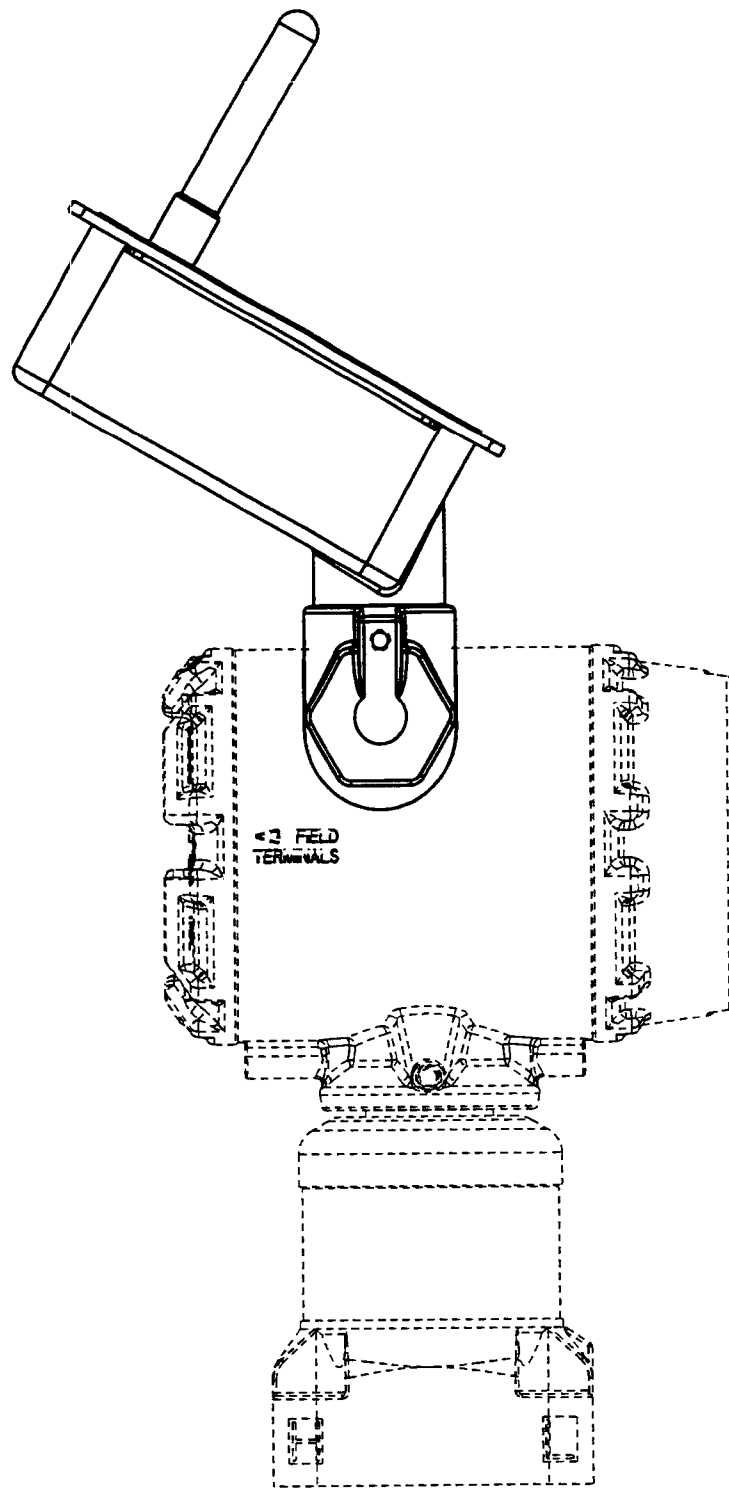


Fig. 2

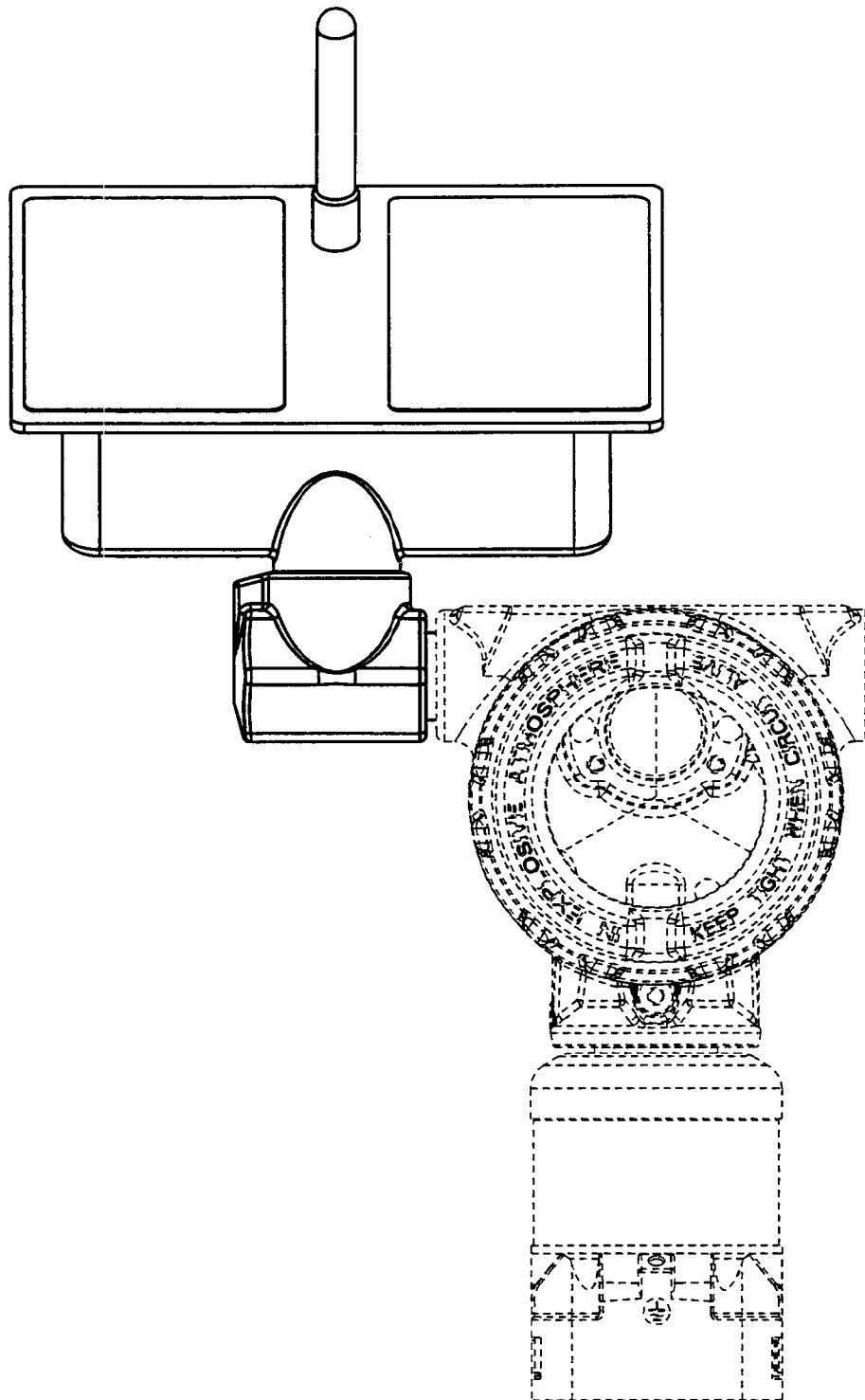


Fig. 3

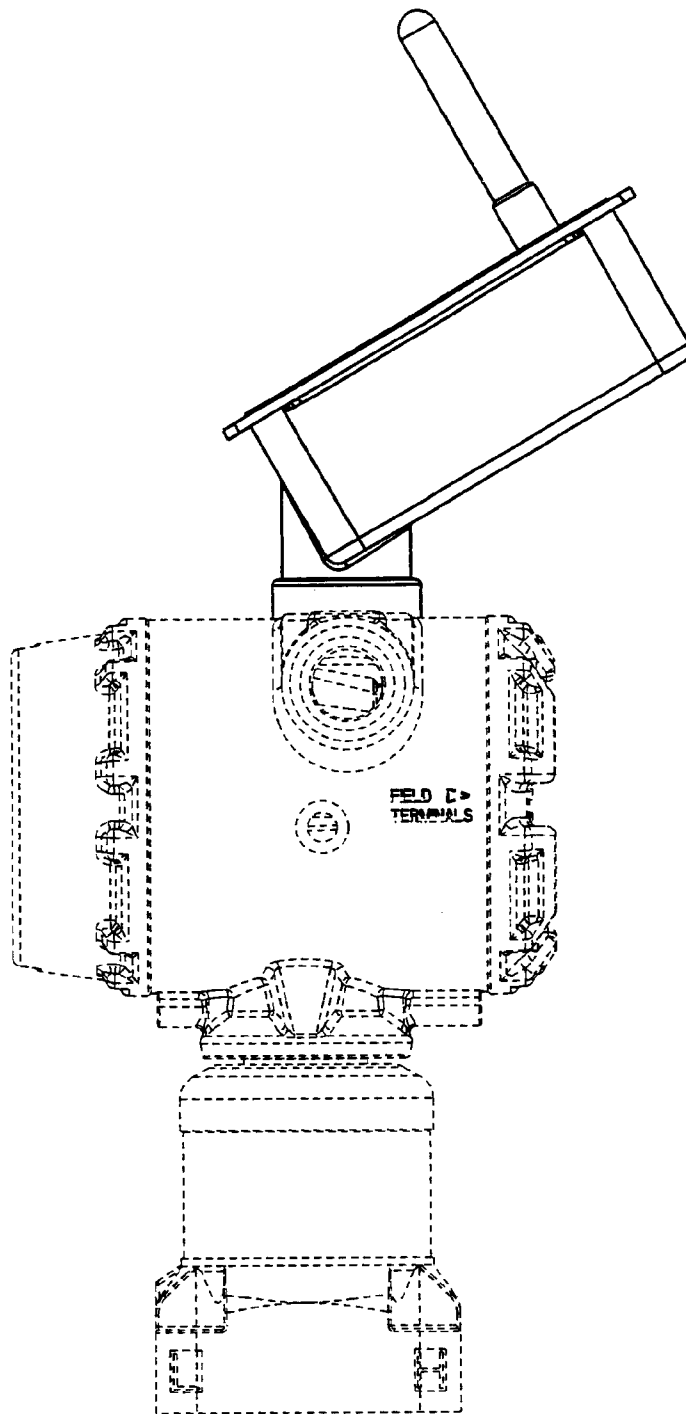


Fig. 4

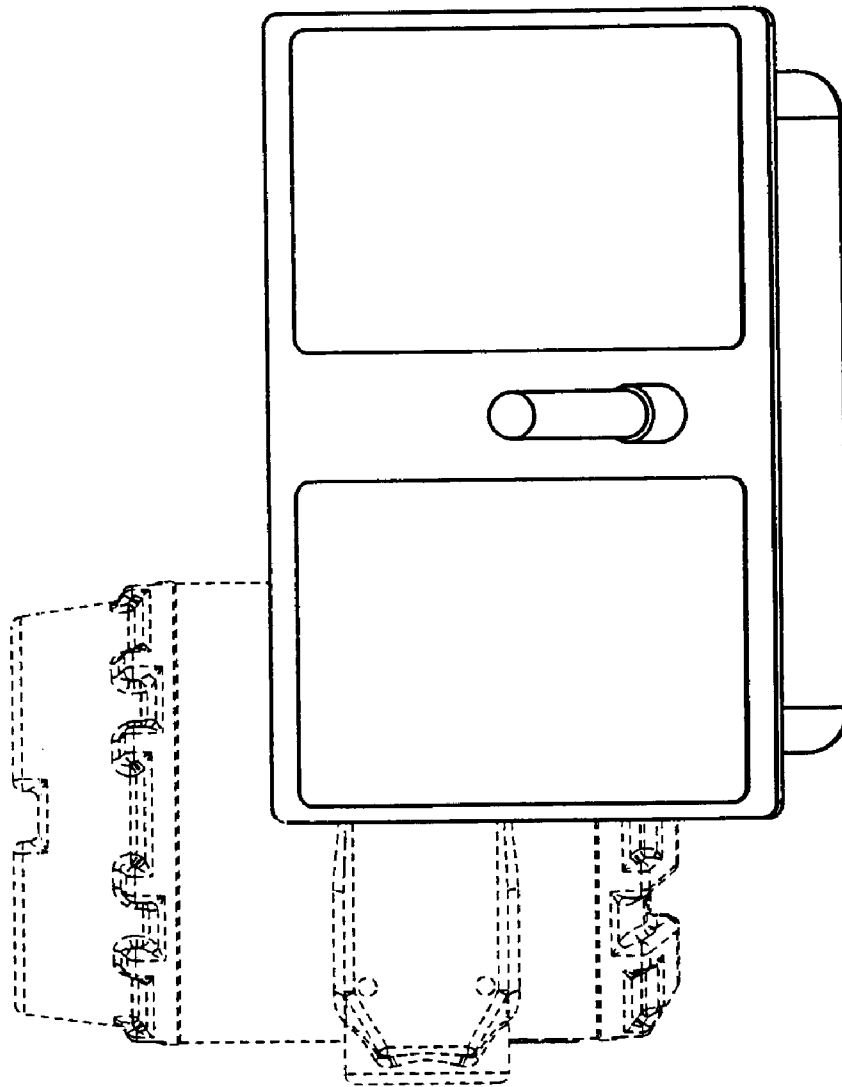


Fig. 5

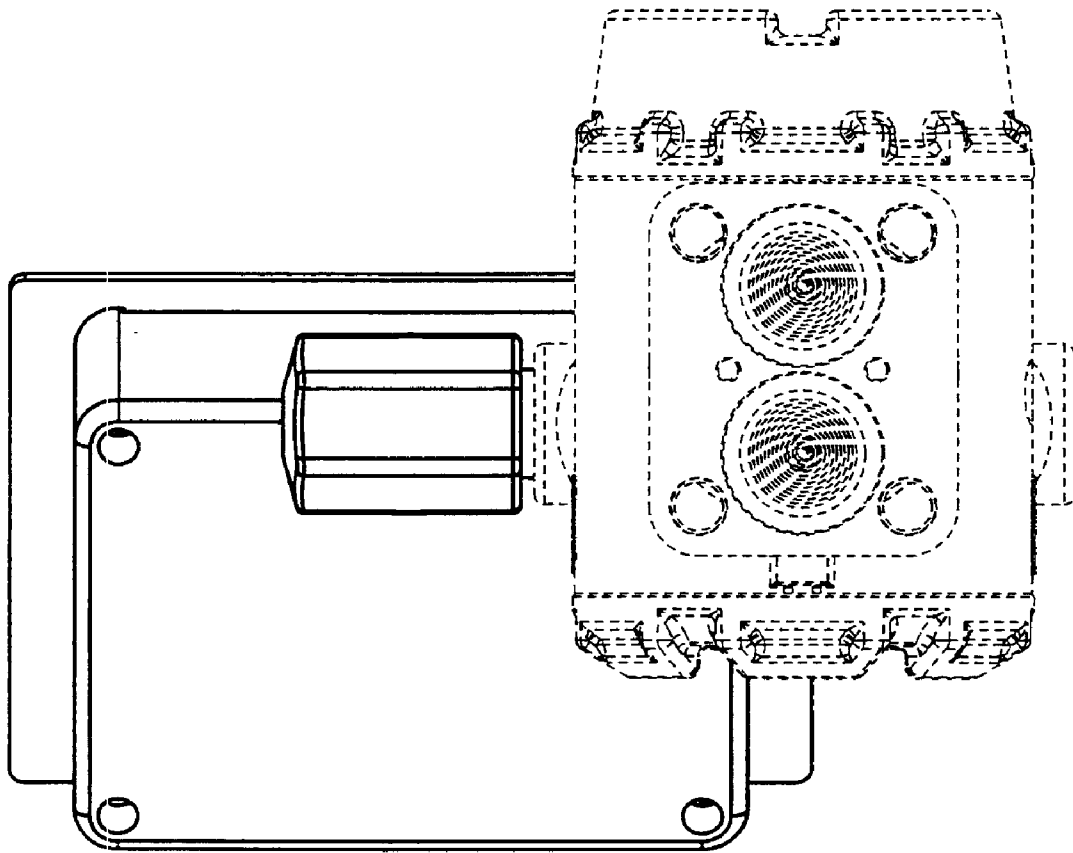


Fig. 6

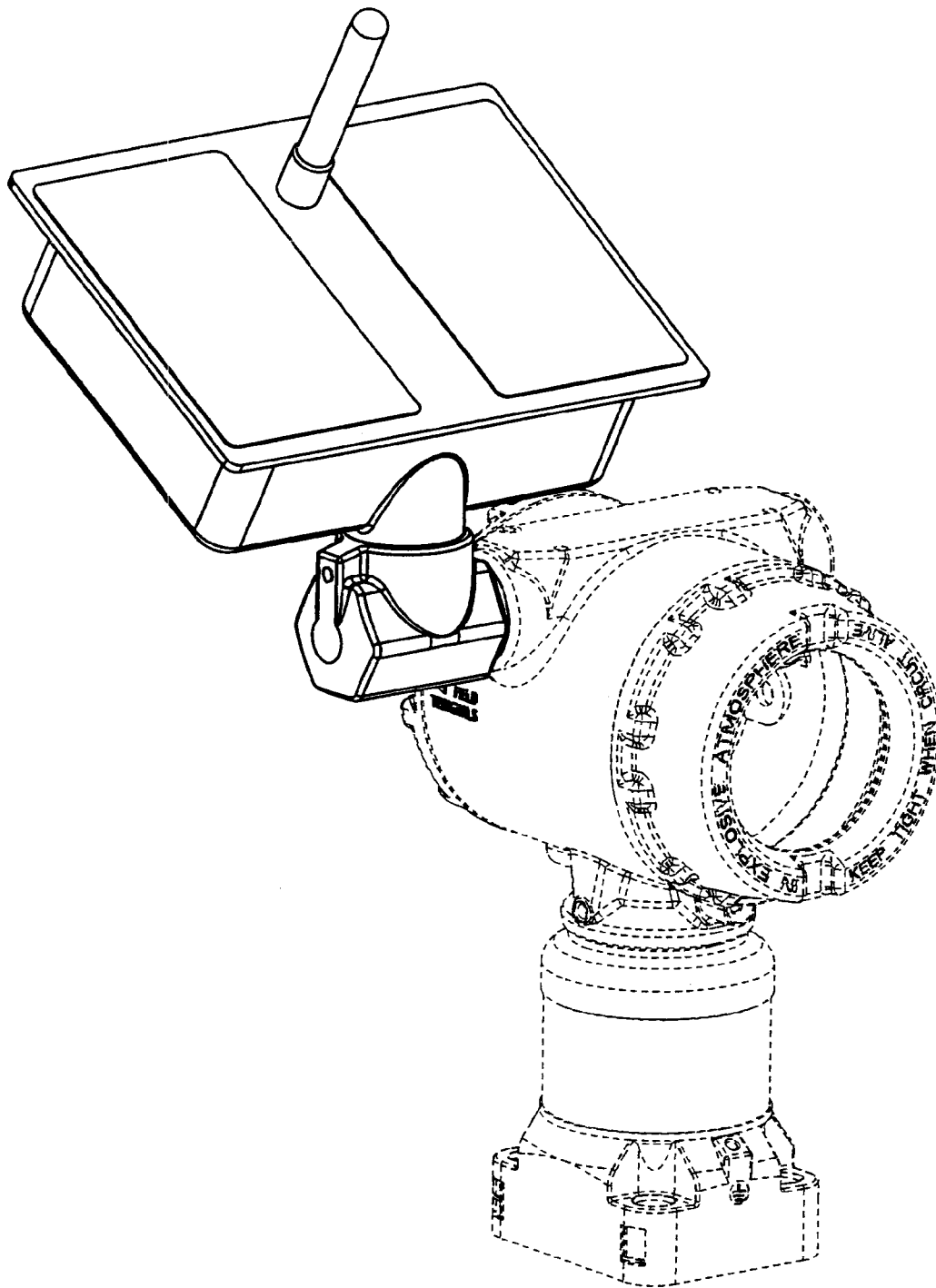


Fig. 7

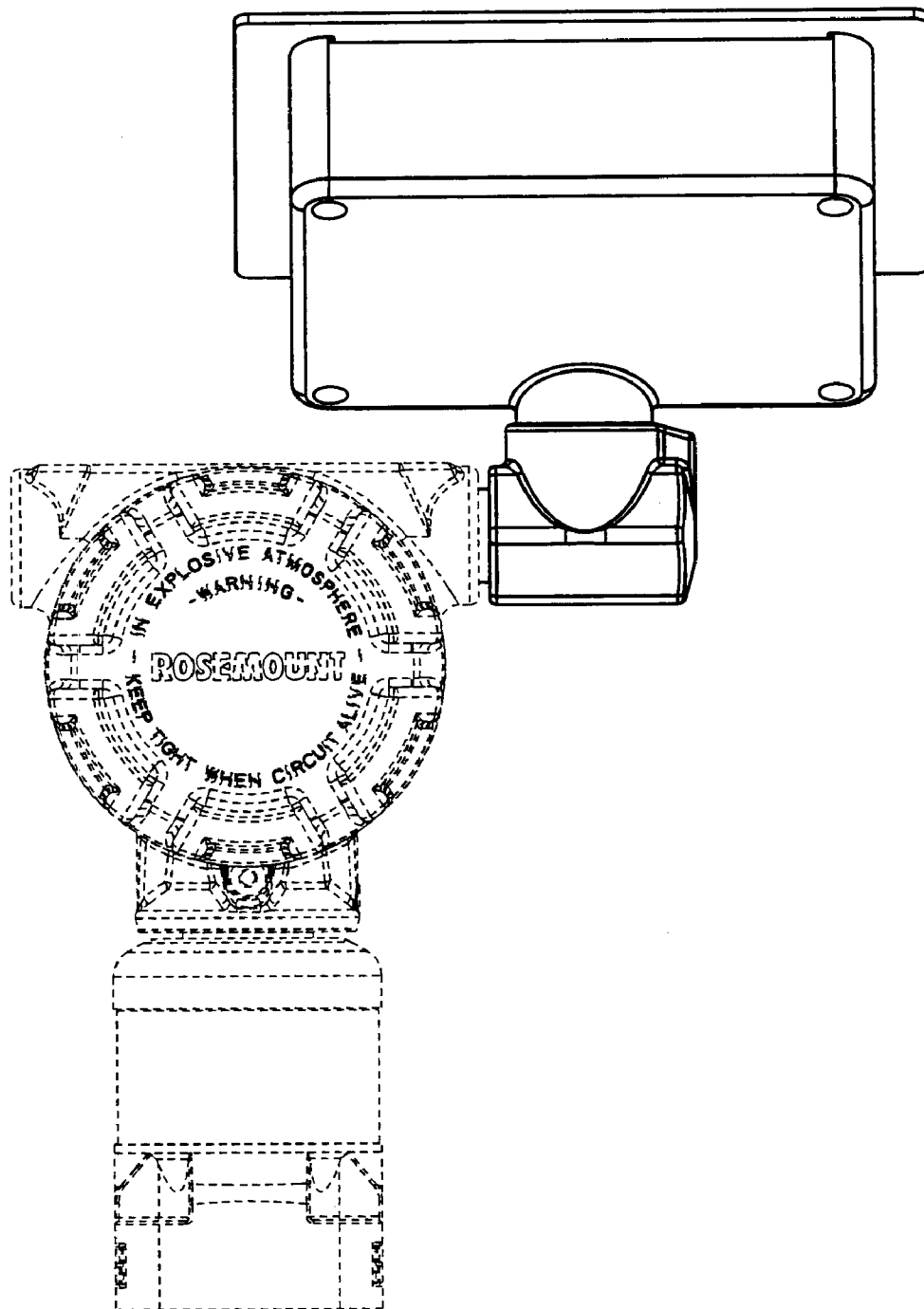


Fig. 8

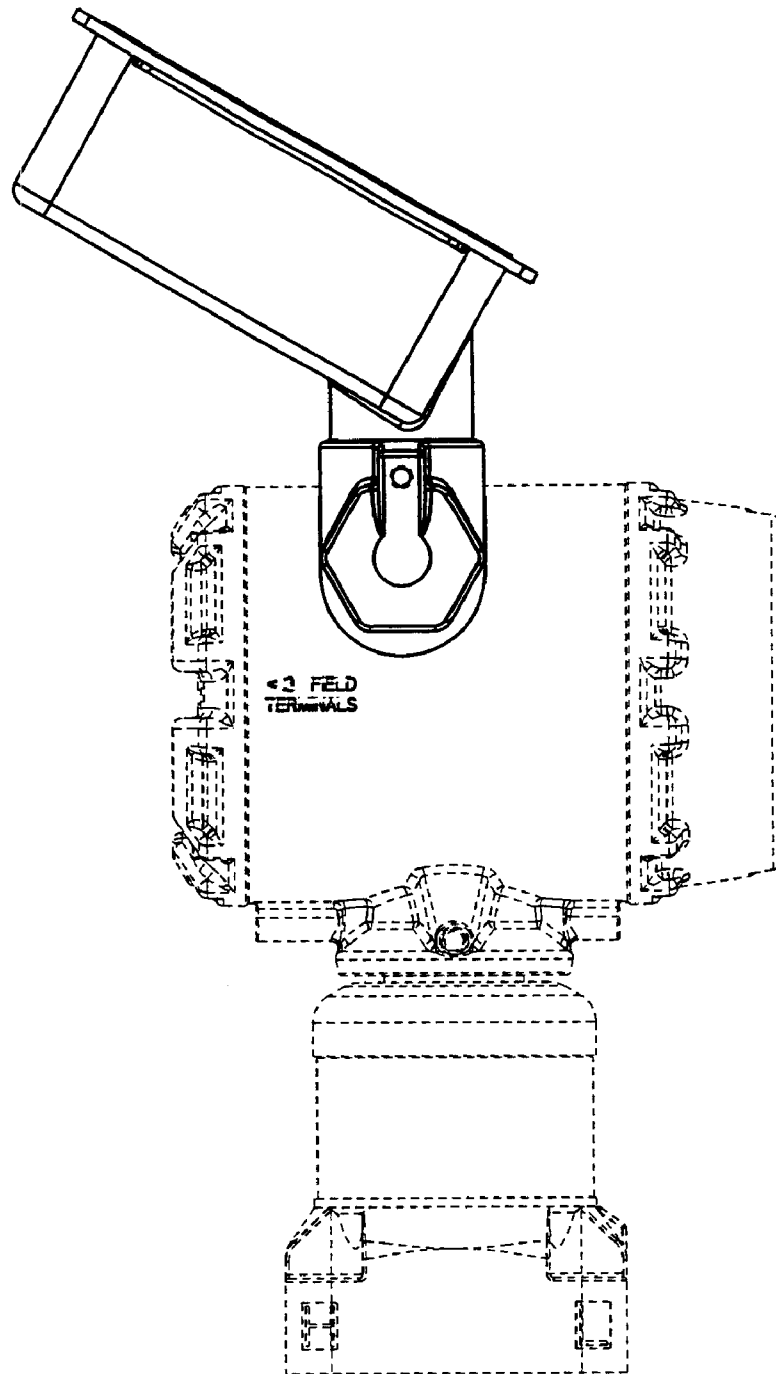


Fig. 9

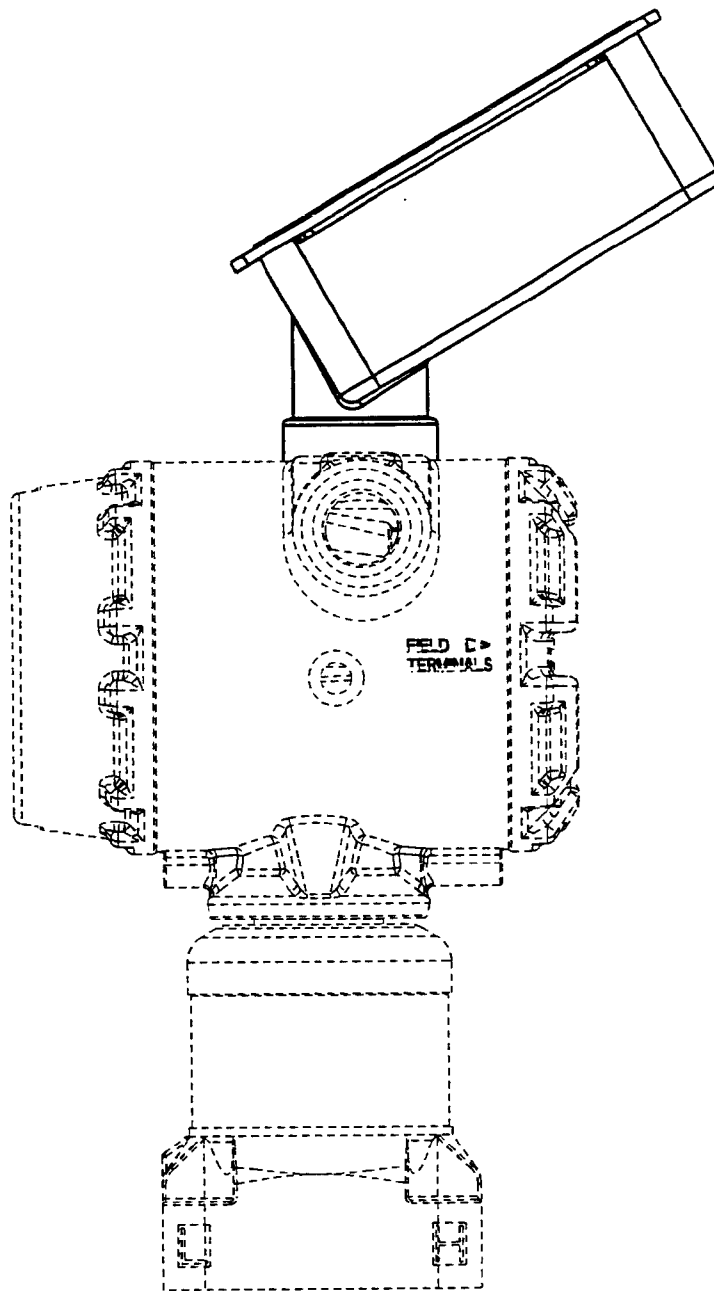


Fig. 11

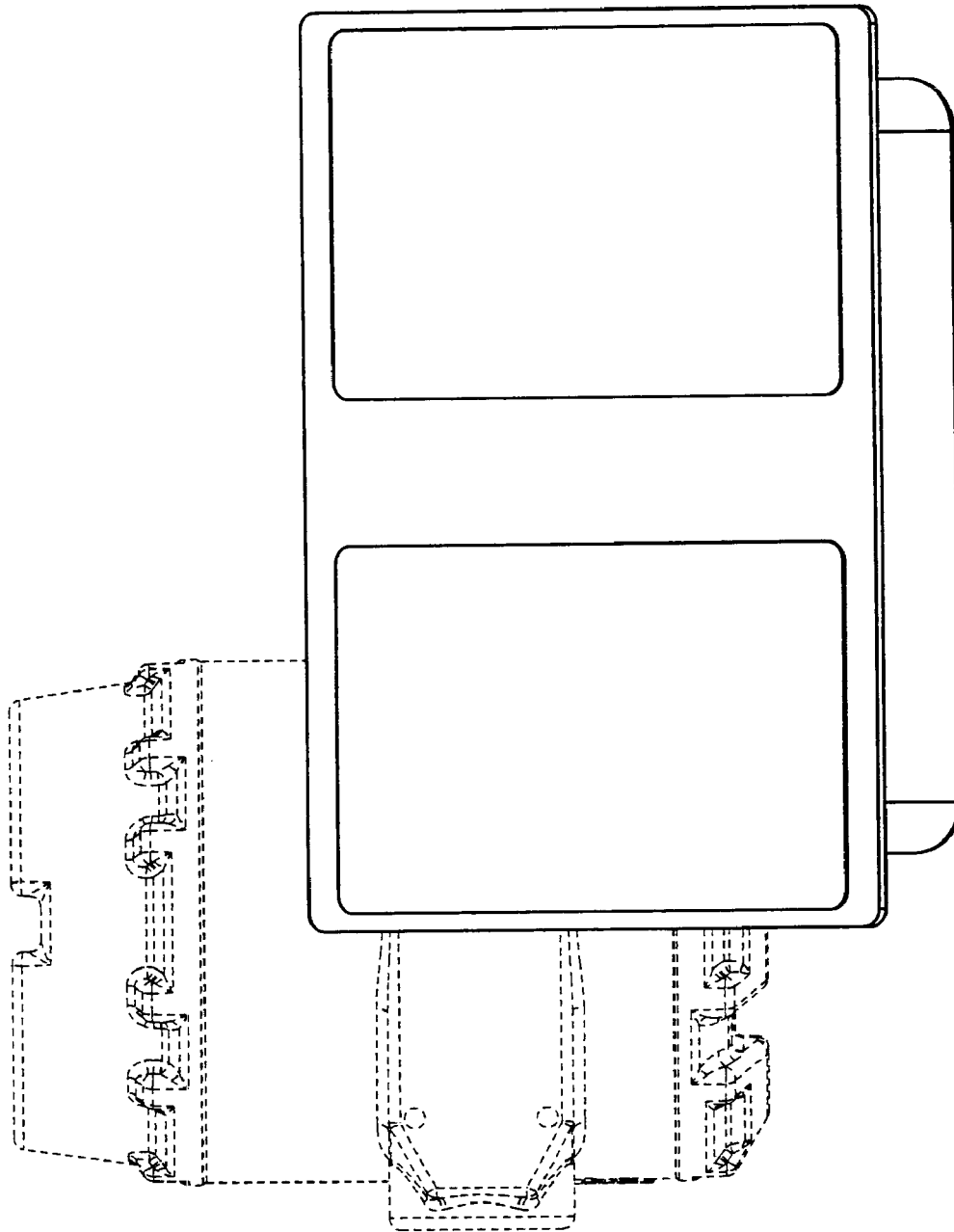


Fig. 12

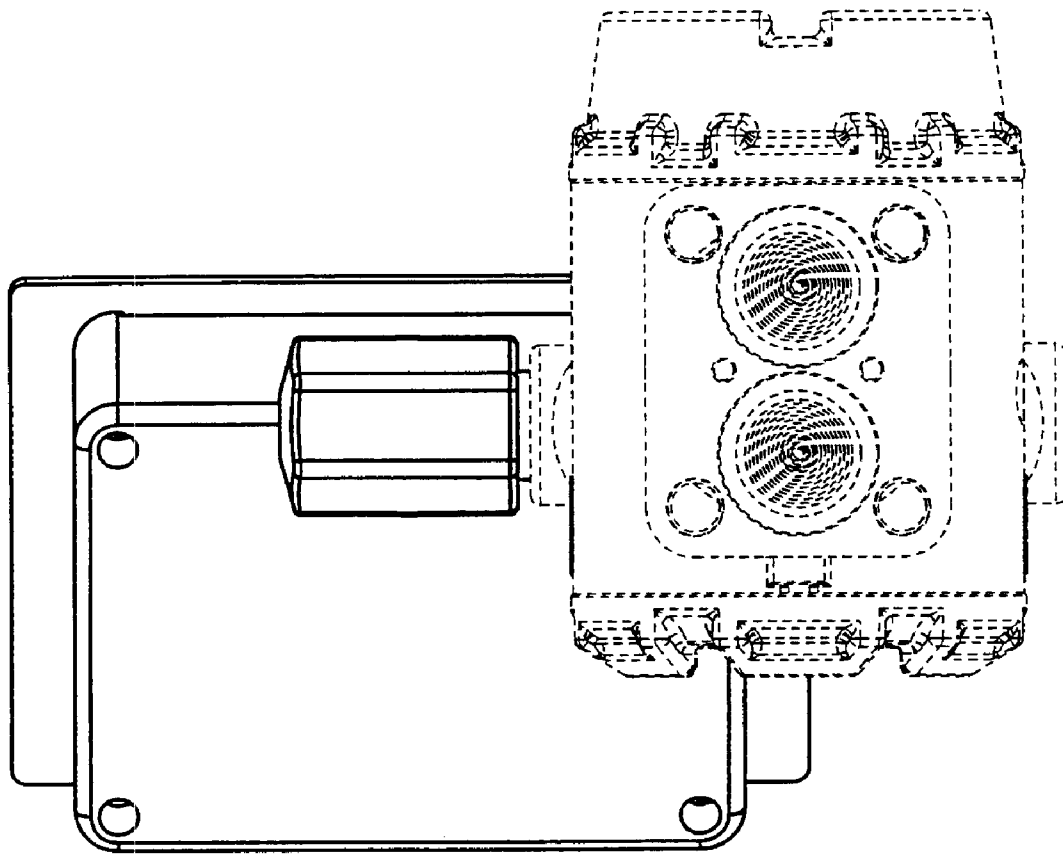


Fig. 13

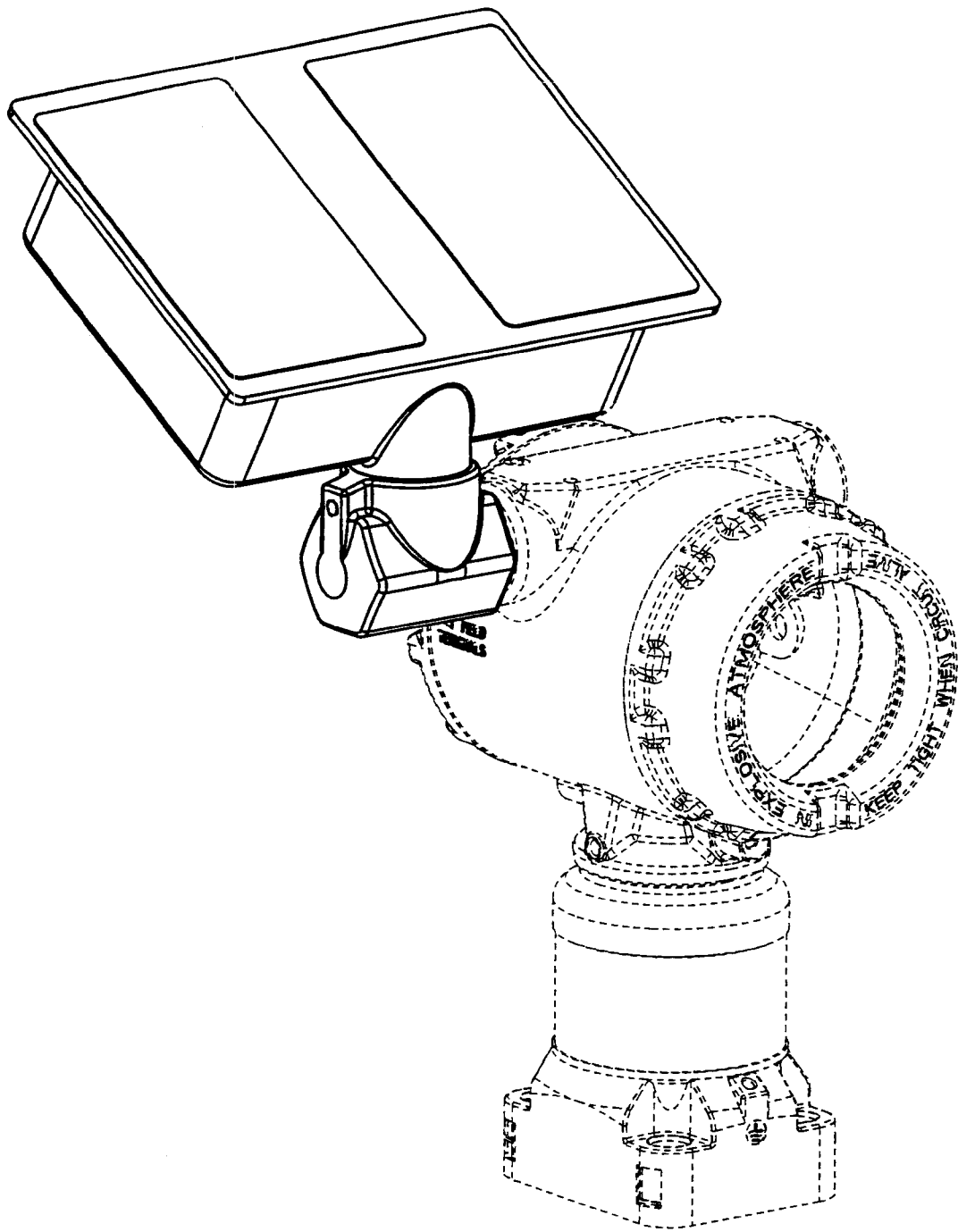


Fig. 14